

Standard SCRs, 25A

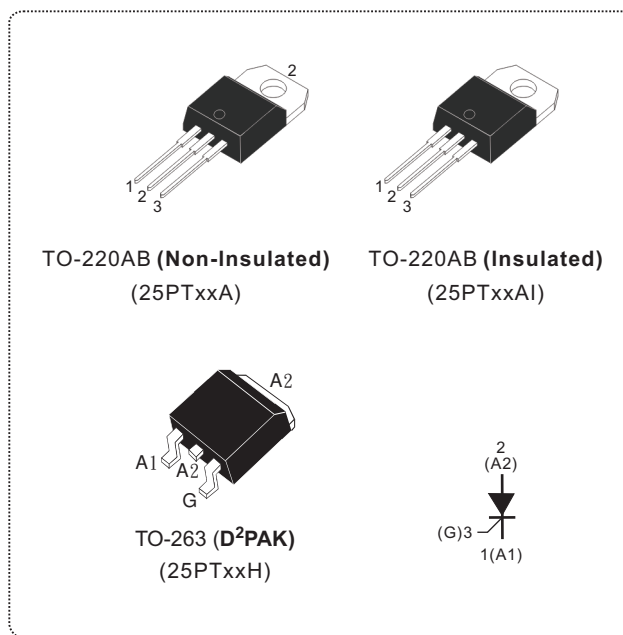
Main Features

Symbol	Value	Unit
$I_{T(RMS)}$	25	A
V_{DRM}/V_{RRM}	600 to 1600	V
I_{GT}	4 to 40	mA

DESCRIPTION

The 25PT series of silicon controlled rectifiers are high performance glass passivated technology, and are suitable for general purpose applications.

Using clip assembly technology, they provide a superior performance in surge current capabilities.



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUE	UNIT
RMS on-state current full sine wave (180° conduction angle)	$I_{T(RMS)}$	TO-263/TO-220AB	$T_c = 100^\circ\text{C}$	25	A
		TO-220AB insulated	$T_c = 83^\circ\text{C}$		
Average on-state current (180° conduction angle)	$I_{T(AV)}$	TO-263/TO-220AB	$T_c = 100^\circ\text{C}$	16	A
		TO-220AB insulated	$T_c = 83^\circ\text{C}$		
Non repetitive surge peak on-state current (full cycle, T_j initial = 25°C)	I_{TSM}	F = 50 Hz	t = 20 ms	300	A
		F = 60 Hz	t = 16.7 ms	314	
I^2t Value for fusing	I^2t	$t_p = 10 \text{ ms}$		450	A^2s
Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ns}$	di/dt	F = 60 Hz	$T_j = 125^\circ\text{C}$	50	$\text{A}/\mu\text{s}$
Peak gate current	I_{GM}	$T_p = 20 \mu\text{s}$	$T_j = 125^\circ\text{C}$	4	A
Maximum gate power	P_{GM}	$T_p = 20 \mu\text{s}$	$T_j = 125^\circ\text{C}$	10	W
Average gate power dissipation	$P_{G(AV)}$	$T_j = 125^\circ\text{C}$		1	W
Repetitive peak off-state voltage	V_{DRM}	$T_j = 125^\circ\text{C}$		600 to 1600	V
Repetitive peak reverse voltage	V_{RRM}				
Storage temperature range	T_{stg}			- 40 to + 150	$^\circ\text{C}$
Operating junction temperature range	T_j			- 40 to + 125	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
SYMBOL	TEST CONDITIONS			25PTxxxx		Unit
				D	–	
I _{GT}	V _D = 12V, R _L = 33Ω		Min.	4	4	mA
V _{GT}			Max.	10	40	
				Max.	1.3	
V _{GD}	V _D = V _{DRM} , R _L = 3.3KΩ R _{GK} = 220Ω	T _J = 125°C	Min.	0.2		V
I _H	I _T = 500mA, Gate open		Max.	20	50	mA
I _L	I _G = 1.2 I _{GT}		Min.	40	90	mA
dV/dt	V _D = 67% V _{DRM} , Gate open	T _J = 125°C	Min.	500		V/μs
V _{TM}	I _T = 50A, t _p = 380μs	T _J = 25°C	Max.	1.6		V
I _{DRM} I _{RRM}	V _D =V _{DRM} , V _R =V _{RRM} R _{GK} = 220Ω	T _J = 25°C	Max.	5		μA
		T _J = 125°C	Max.	2		mA
V _{to}	Threshold Voltage	T _J = 125°C	Max.	0.77		V
R _d	Dynamic Resistance	T _J = 125°C	Max.	14		mΩ

THERMAL RESISTANCE					
SYMBOL	Parameter			VALUE	UNIT
R _{th(j-c)}	Junction to case (DC)		D ² PAK/TO-220AB	1.0	°C/W
			TO-220AB insulated	2.0	
R _{th(j-a)}	Junction to ambient	S = 1 cm ²	TO-263(D ² PAK)	45	°C/W
			TO-220AB/TO-220AB insulated	60	

S=Copper surface under tab

PRODUCT SELECTOR							
PART NUMBER	VOLTAGE (xx)					SENSITIVITY	PACKAGE
	600 V	800 V	1000 V	1200 V	1600 V		
25PTxxA/25PTxxAI	V	V	V	V	V	40 mA	TO-220AB
25PTxxH	V	V	V	V	V	40 mA	D ² PAK
25PTxxA-D/25PTxxAI-D	V	V	V	V	V	4~10 mA	TO-220AB
25PTxxH-D	V	V	V	V	V	4~10 mA	D ² PAK

ORDERING INFORMATION					
ORDERING TYPE	MARKING	PACKAGE	WEIGHT	BASE Q'TY	DELIVERY MODE
25PTxxA-y	25PTxxA-y	TO-220AB	2.0g	50	Tube
25PTxxAI-y	25PTxxAI-y	TO-220AB (insulated)	2.3g	50	Tube
25PTxxH-y	25PTxxH-y	TO-263(D ² PAK)	2.0g	50	Tube

Note: xx = voltage , y = sensitivity

ORDERING INFORMATION SCHEME

	25	PT	06	AI	-	D
Current						
25 = 25A, $I_{T(RMS)}$						
SCR series						
Voltage Code						
06 = 600V						
08 = 800V						
10 = 1000V						
12 = 1200V						
16 = 1600V						
Package type						
A = TO-220AB (non-insulated)						
AI = TO-220AB (insulated)						
H = TO-263 (D ² PAK)						
I_{GT} Sensitivity						
D = 4~10mA						
Blank = 4~40mA						

Fig.1 Maximum average power dissipation versus average on-state current.

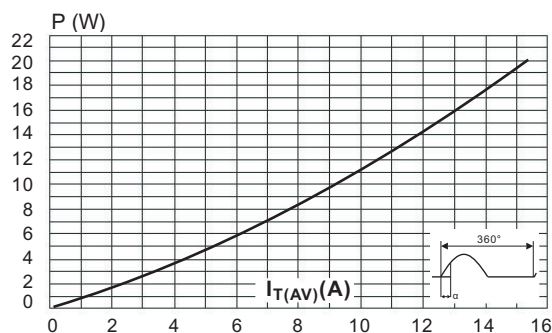


Fig.2 Average and DC on-state current versus case temperature.

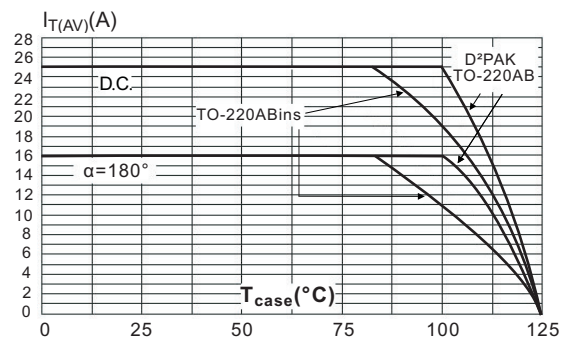


Fig.3 Average and DC on-state current versus ambient temperature.

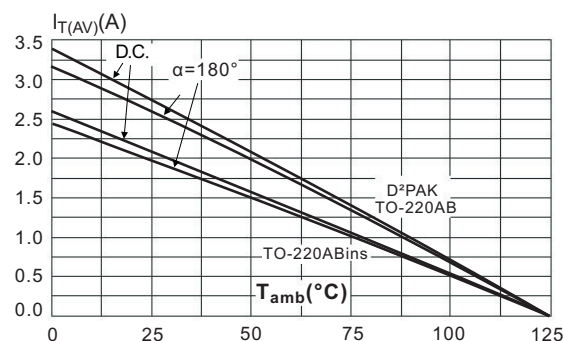


Fig.4 Relative variation of thermal impedance versus pulse duration.(D²PAK, and TO-220AB)

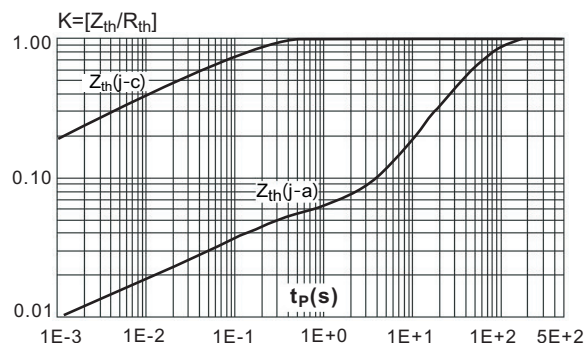


Fig.5 Relative variation of thermal impedance versus pulse duration. (TO-220AB ins)

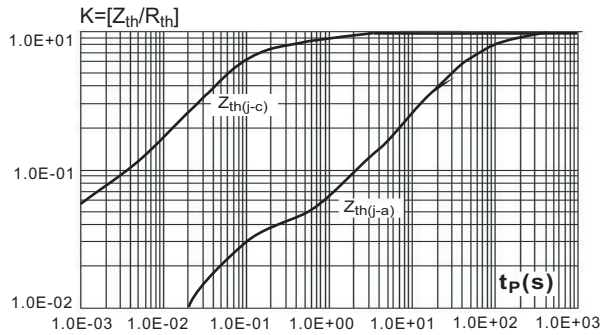


Fig.6 Relative variation of gate trigger holding, and latching currents versus junction temperature.

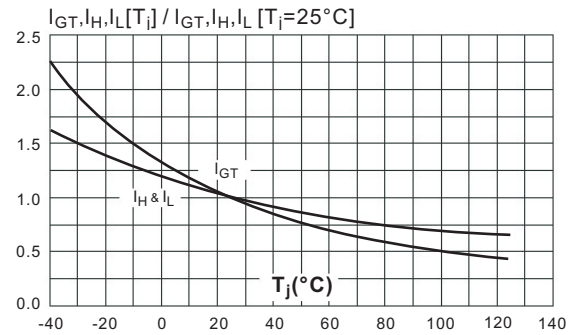


Fig.7 Surge peak on-state current versus number of cycles.

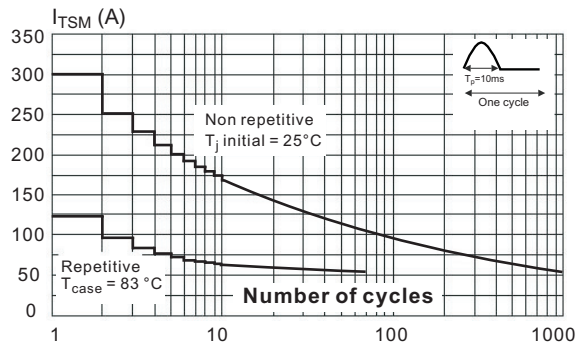


Fig.8 Non-repetitive surge peak on-state current, and corresponding values of I^2t

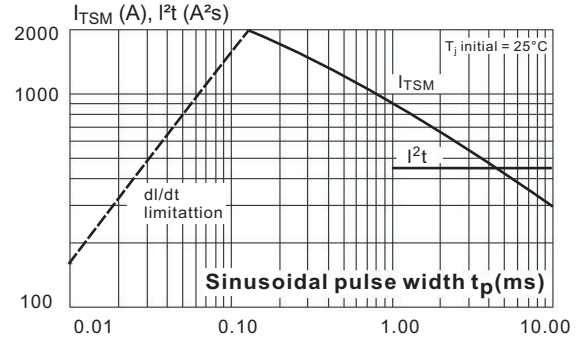


Fig.9 On-state characteristics (maximum values)

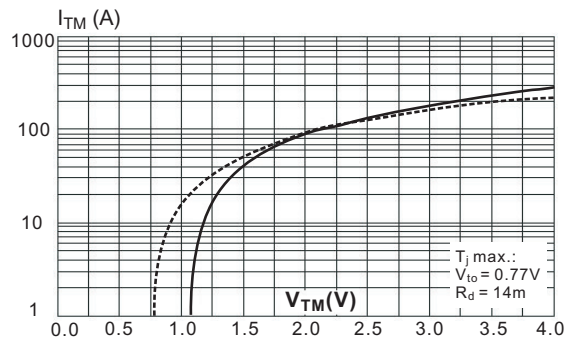
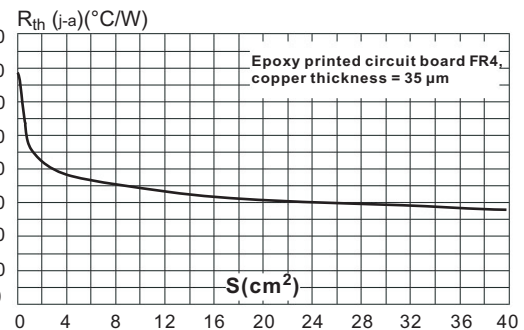
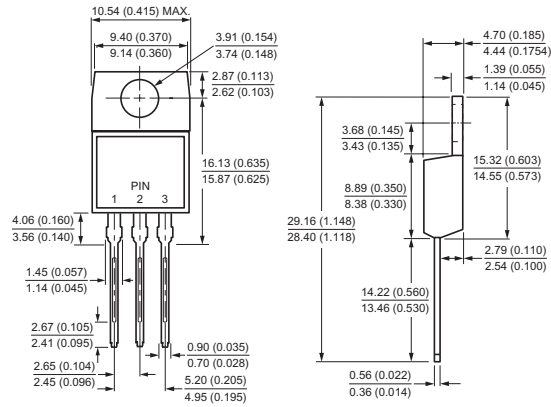


Fig.10 Thermal resistance junction to ambient versus copper surface under tab (D²PAK)

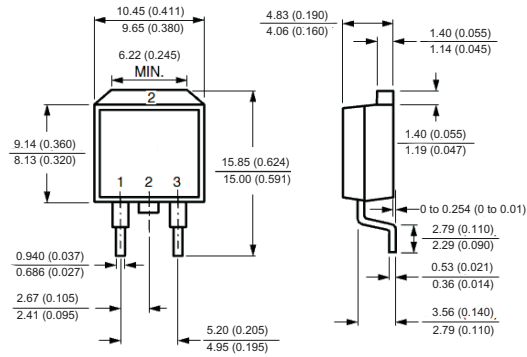


Case Style

TO-220AB



TO-263(D²PAK)



All dimensions in millimeters(inches)

